## **LMS202**

LMS202 5V Single Supply TIA/EIA-232 Dual Transceivers



Literature Number: SNLS166D



## **LMS202**

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## 5V Single Supply TIA/EIA-232 Dual Transceivers

## **General Description**

The LMS202 features two transmitters and two receivers for RS-232 communication. It has a DC-to-DC converter that permits the device to operate with only a single +5V power supply. The on-chip DC-to-DC converter which utilizes four external 0.1µF capacitors to generate dual internal power supplies for RS-232 compatible output levels.

The device meet EIA/TIA-232E and CCITT V.28 specifications up to 230kbits/sec. The LMS202 is available in a 16 pin narrow and Wide SOIC package.

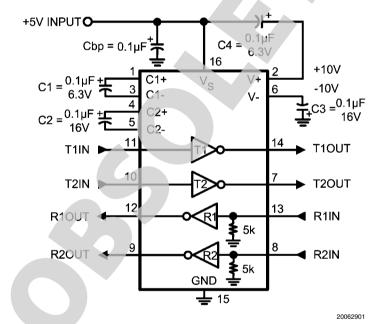
#### **Features**

- Single +5V power supply
- 230 kbps data rate
- On-board DC-to-DC converter
- 0.1µF charge pump capacitors
- Drop-in replacement to Maxim's MAX202

## **Applications**

- POS equipment (Bar code reader)
- Hand-held equipment
- General purpose RS-232 communication

## **Connection Diagram and Typical Circuit**



# Pin Descriptions

Pin Number	Pin Name	Pin Function		
1, 3	C1+, C1-	External capacitor connection pins. Recommended external capacitor C1 = 0.1µF (6.3V)		
2	V+	Positive supply for TIA/EIA-232E drivers. Recommended external capacitor C4 = 0.1µF (6.3V)		
4, 5	C2+, C2-	External capacitor connection pins. Recommended external capacitor C2 = 0.1µF (16V)		
6	V-	Negative supply for TIA/EIA-232E drivers. Recommended external capacitor C3 = 0.1µF (16V)		
7, 14	T1out, T2out	Transmitter output pins conform to TIA/EIA-232E levels. The typical transmitter output swing is $\pm 8V$		
		when loaded $3k\Omega$ load to ground. The open-circuit output voltage swings from (V+ $-$ 0.6V) to V-		
8,13	R1in, R2in	Receiver inputs accept TIA/EIA-232		
9, 12	R1out and R2out	Receiver output pins are TTL/CMOS compatible		
10, 11 Tin1, Tin2 Transmitter input pins are TTL/CMOS compatible. In		Transmitter input pins are TTL/CMOS compatible. Inputs of transmitter do not have pull-up		
		resistors. Connect all unused transmitter inputs to ground		
15	GND	Ground pin		
16	V <sub>S</sub>	Power supply pin for the device, +5V (±10%)		

## **Ordering Information**

Package	Part Number	Package Marking	Transport Media	NSC Drawing	
	LMS202CM	1110000011	48 Units/Rail		
40 Dia 0010	LMS202CMX	LMS202CM	2.5k Units Tape and Reel		
16-Pin SOIC	LMS202IM	LMS202IM	48 Units/Rail	M16A	
	LMS202IMX	LIVISZUZIIVI	2,5k Units Tape and Reel	1	
	LMS202CMW	LMS202CMW	45 Units/Rail	M16B	
16-Pin Wide SOIC	LMS202CMWX	LIVISZUZGIVIVV	1.0k Units Tape and Reel		
10-Fill Wide SOIC	LMS202IMW	LMS202IMW	45 Units/Rail	MITOB	
	LMS202IMWX	LIVISZUZIIVIVV	1.0k Units Tape and Reel		

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-65°C to +150°C

## **Absolute Maximum Ratings** (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

 $V_{\rm S}$ -0.3V to 6V V+  $(V_S - 0.3V)$  to + 14V +0.3V to -14V V-Driver Input Voltage, T<sub>IN</sub> -0.3V to (V + +0.3V)Receiver Input Voltage, RIN ± 30V Driver Output Voltage T<sub>O</sub> (V - -0.3V to (V + + 0.3V)Receiver Output Voltage Ro -0.3 to  $(V_S + 0.3)$ Short Circuit Duration, To Continuous **ESD** Rating 2kV Human Body Model (Note 2)

Soldering Information
Infrared or Convection 235°C (20sec.)
Junction Temperature 150°C

## **Operating Ratings**

Storage Temperature Range

Supply Voltage  $V_{\rm S}$  4.5V to 5.5V Ambient Temperature Range,  $T_{\rm A}$  Commercial (C) 0°C to +70°C Industrial (I) -40°C to +85°C Package Thermal Resistance (*Note* 

SO 71°C/W WSO 55°C/W

### **Electrical Characteristics**

Over recommended operating supply and temperature ranges unless otherwise specified

200V

 $C1 = C2 = C3 = C4 = Cbp = 0.1 \mu F$ 

Machine Model (Note 6)

Symbol	Parameter	Conditions	Min (Note 5)	Тур	Max (Note 5)	Units
DC Charac	teristics		1	Į		
I <sub>s</sub>	Supply Current	No Load, T <sub>A</sub> = 25°C		1	7	mA
Logic			•	•		
I <sub>INPUT</sub>	Input Leakage Current	$T_{IN} = 0V \text{ to } V_{S}$			±10	μA
$V_{THL}$	Input Logic Theshold Low	T <sub>IN</sub>			0.8	V
V <sub>THH</sub>	Input Logic Theshold High	T <sub>IN</sub>	2.0			V
V <sub>OL</sub>	TTL/CMOS Output Voltage Low	$R_{OUT}$ , $I_{OUT} = 3.2mA$			0.4	V
V <sub>OH</sub>	TTL/CMOS Output Voltage High	$R_{OUT}$ , $I_{OUT} = -1.0$ mA	3.5	V <sub>S</sub> -0.1		V
RS-232 Re	ceiver Inputs			l .		
V <sub>RI</sub>	Receiver Input Voltage Range		-30		+30	V
$V_{RTHL}$	Receiver Input Theshold Low	$V_{\rm S} = 5 \text{V}, T_{\rm A} = 25 ^{\circ}\text{C}$	0.8	1.4		V
V <sub>RTHH</sub>	Receiver Input Theshold High	$V_S = 5V, T_A = 25^{\circ}C$		2	2.4	V
V <sub>HYST</sub>	Receiver Input Hysteresis	V <sub>S</sub> = 5V	0.2	0.6	1.0	V
R <sub>I</sub>	Receiver Input Resistance	$V_{S} = 5V, T_{A} = 25^{\circ}C$	3	5	7	kΩ
RS-232 Tra	nsmitter Outputs	7	•	•		
V <sub>O</sub>	Transmitter Output Voltage Swing	All transmitters loaded with $3k\Omega$ to GND	±5	±8		V
R <sub>o</sub>	Output Resistance	$V_S = V + = V - = 0V$ ,	300			Ω
		$V_O = \pm 2V$				
I <sub>os</sub>	Output Short Circuit Current			±11	±60	mA
Timing Cha	aracteristics				<b>'</b>	
DR	Maximum Data Rate	C <sub>L</sub> = 50pF to 1000pF,	230			kbps
		$R_L = 3k\Omega$ to $7k\Omega$				
T <sub>RPLH</sub> T <sub>RPHL</sub>	Receiver Propagation Delay	C <sub>L</sub> = 150pF		0.08	1	μs

Symbol	Parameter	Conditions	Min ( <i>Note 5</i> )	Тур	Max (Note 5)	Units
T <sub>DPLH</sub>	Transmitter Propagation Delay	$R_L = 3k\Omega$ , $C_L = 2500pF$ All transmitters loaded		2.4		μs
V <sub>SLEW</sub>	Transition Region Slew Rate	$T_A = 25$ °C, $V_S = 5V$ $C_L = 50$ pF to 1000pF, $R_L = 3$ kΩ to 7kΩ Measured from +3V to -3V or vice versa	3	6	30	V/µs

Note 1: Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is intended to be functional, but specific performance is not guaranteed. For guaranteed specifications and the test conditions, see the Electrical Characteristics.

Note 2: Human Body Model,  $1.5k\Omega$  in series with 100pF

Note 3: The maximum power dissipation is a function of  $T_{J(MAX)}$ ,  $\theta_{JA}$ , and  $T_A$ . The maximum allowable power dissipation at any ambient temperature is  $P_D = (T_J - T_A)/(\theta_{JA})$ . All numbers apply for packages soldered directly onto a PC board.

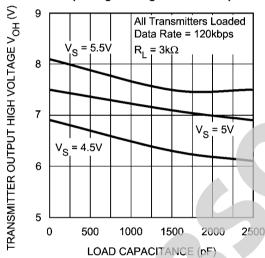
Note 4: Typical Values represent the most likely parametric norm.

Note 5: All limits are guaranteed by testing or statistical analysis

Note 6: Machine model,  $0\Omega$  in series with 200pF

### **Typical Characteristics**

#### Transmitter Output High Voltage vs. Load Capacitance



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## **Application Information**

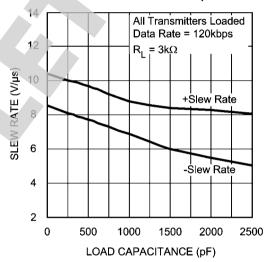
#### **CAPACITOR SELECTION**

The recommended capacitors are  $0.1\mu F$ . However, larger capacitors for the charge pump may be used to minimized ripples on V+ and V- pins.

#### **POWER SUPPLY DECOUPLING**

In some applications that are sensitive to power supply noise from the charge pump, place a decoupling capacitor, Cbp,

#### Transmitter Slew Rate vs. Load Capacitance



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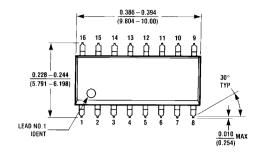
from  $V_S$  to GND. Use at least a  $0.1\mu F$  capacitor or the same size as the charge pump capacitors (C1 – C4).

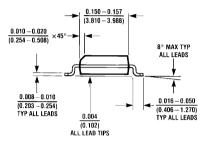
#### **CHARGED PUMP**

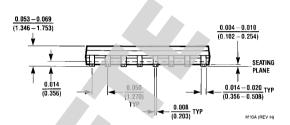
The dual internal charged-pump provides the  $\pm 10V$  to the to transmitters. Using capacitor C1, the charge pump converts +5V to +10V then stores the +10V in capacitor C3. The charge pump uses capacitor C2 to invert the +10V to -10V. The -10V is then stored in capacitor C4.

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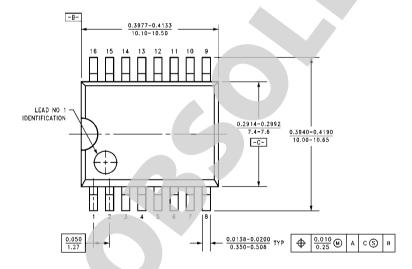
## Physical Dimensions inches (millimeters) unless otherwise noted

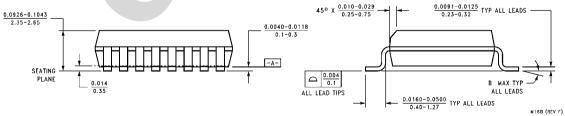






16-Pin SOIC NS Package Number M16A





16-Pin Wide SOIC NS Package Number M16B

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### **Notes**

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